

CESION

El (la) abajo firmante (En adelante EL CEDENTE)

1. **QIAN, Bin**
2. **LIU, Chenchen**
3. **ZHOU, Zhengchun**
4. **KEREN, Rani**
5. **HUANG, Lei**
6. **YANG, Xun**
7. **YANG, Yang**

en su carácter de inventor /diseñador con domicilio en:
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6. Huawei Administration Building Bantian, Longgang District Shenzhen, Guangdong 518129, China
7. Southwest Jiaotong University, West Park of High-Tech Zone Chengdu, Sichuan 611756, China

por el presente documento declara que cede todos y cada uno de los derechos que le corresponden o puedan corresponderle sobre la siguiente invención, modelo de utilidad, diseño industrial **No. PCT/CN2023/134947**

a: **HUAWEI TECHNOLOGIES CO., LTD.**

con domicilio en Huawei Administration Building Bantian, Longgang District Shenzhen, Guangdong 518129, China

En prueba de la mutua aceptación de esta cesión ambas partes CEDENTE y CESIONARIO firman el presente documento.

Dado y firmado en

A los Días de de

1. **QIAN, Bin**

El Cedente

2. **LIU, Chenchen**

El Cedente

3. **ZHOU, Zhengchun**

El Cedente

ASSIGNMENT

The undersigned (Hereinafter THE ASSIGNOR)

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Granted and signed at Shenzhen, China

on this 8 day of May of 2025

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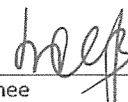
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